

Data sheet acquired from Harris Semiconductor SCHS033C - Revised October 2003

BCD-to-Decimal Decoder

High-Voltage Types (20-Volt Rating)

CD4028B types are BCD-todecimal or binary-to-octal decoders consisting of buffering on all 4 inputs, decodinglogic gates, and 10 output buffers. A BCD code applied to the four inputs, A to D, results in a high level at the selected one of 10 decimal decoded outputs. Similarly, a 3-bit binary code applied to inputs A through C is decoded in octal code at output 0 to 7 if D = "0". High drive capability is provided at all outputs to enhance dc and dynamic performance in high fan-out applications.

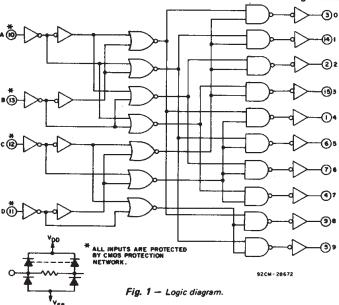
The CD4028B-Series types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Features:

- BCD-to-decimal decoding or binary-to-octal decoding
- High decoded output drive capability
- "Positive logic" inputs and outputs. decoded outputs go high on selection
- Medium-speed operation. . . .
 - tpHL, tpLH = 80 ns (typ.) @ VDD = 10 V
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full packagetemperature range):
 - 1 V at V_{DD} = 5 V
 - 2 V at V_{DD} = 10 V
- 2.5 V at V_{DD} = 15 V = 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

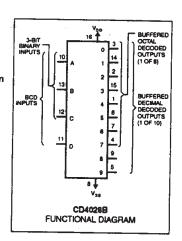
- Code conversion ■ Indicator-tube decoder
- Address decoding—memory selection control



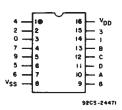
MAXIMUM RATINGS, Absolute-Maximum Values:

LEAD TEMPERATURE (DURING SOLDERING):

DC SUPPLY-VOLTAGE RANGE, (VDD)	
Voltages referenced to VSS Terminal)	0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	0.5V to V _{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (PD):	
For T _A = -55°C to +100°C	500mW
For T _A = +100°C to +125°C	Derate Linearity at 12mW/OC to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (A	All Package Types) 100mW
OPERATING-TEMPERATURE RANGE (TA)	55°C to +125°C
STORAGE TEMPERATURE RANGE (Teta)	



CD4028B Types



Top View TERMINAL DIAGRAM

TABLE I - TRUTH TABLE

D	С	В	Α	0	1	2	3	4	5	6	7	8	9
0	0	0	0	1	0	0	0	0	0	0	0	0	0
0	0	0	1	0	1	0	0	0	0	0	0	0	0
0	0	1	0	0	0	1	0	0	0	0	0	0	0
0	0	1	1	0	0	0	1	0	0	0	0	0	0
0	1	0	0	0	0	0	0	1	0	0	0	0	0
0	1	0	1	0	0	0	0	0	1	0	0	0	0
0	1	1	0	0	0	0	0	0	0	1	0	0	0
0	1	1	1	0	0	0	0	0	0	0	1	0	0
1	0	0	0	0	0	0	0	0	0	0	0	1	0
1	0	0	1	0	0	0	0	0	0	0	0	0	1
1	0	1	0	0	0	0	0	0	0	0	0	0	0
1	0	1	1	0	0	0	0	0	0	0	0	0	0
1	1	0	0	0	0	0	0	0	0	0	0	0	0
1	1	0	1	0	0	0	0	0	0	0	0	0	0
1	1	1	0	0	0	0	0	0	0	0	0	0	0
1	1	1	1	0	0	0	0	0	0	0	0	0	0

I = HIGH LEVEL

0 = LOW LEVEL

CD4028B Types

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	L	IMITS	UNITS
	MIN.	MAX.	
Supply Voltage Range			
(For T _A = Full Package Temperature Range)	3	18	V

STATIC ELECTRICAL CHARACTERISTICS *

CHARACTER-	CON	DITIO	vs ["]	LIMI	LIMITS AT INDICATED TEMPERATURES (°C)										
ISTIC	Vo	VIN	VDD					<u> </u>	+25		UNITS				
	(v)	(V)	(V)	-55	-40	+85	+125	Min.	Тур.	Max.	1				
Quiescent Device	_	0,5	5	5	5	150	150	- :	0.04	5					
Current,	-	0,10	10	10	10	300	300	-	.0.04	- 10	1.				
IDD Max.	-	0,15	15	20	20	600	600	- :	0.04	20	μΑ				
	-	0,20	20	100	100	3000	3000	-	0,08	100	1				
Output Low	0.4	0,5	5	0.64	0.61	0.42	0,36	0.51	1	-					
(Sink) Current	0,5	0,10	10	1.6	1.5	1,1	0.9	1.3	2.6		1				
IOL Min.	1,5	0,15	15	4.2	4	2.8	2.4	34	6.8	-	1				
Output High (Source)	4.6	0,5	5	-0.64	-0,61	-0.42	-0.36	-0.51	1	-	mA				
	2.5	0,5	- 5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	-					
Current, IOH Min,	9.5	0,10	10	-1.6	-1,5	-1.1	-0.9	-1.3	-2.6	-					
TOH WITH	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	- 6.8	-					
Output Voltage:	-	0,5	5		0	.05		_	0	0.05					
Low-Level, VOL Max.	_	0,10	10		0	,05		-	0	0.05					
*OL 1418X.	-	0,15	15		0.	.05		-	0	0.05					
Output Voltage:	-	0,5	5		4.	.95		4.95	5	-	*				
High Level	_	0,10	10		9.	95		9,95	10	-					
VOH Min.	_	0,15	15		14	.95		14.95	15	-					
Input Low	0.5, 4.5		5		1	.5		_	-	1.5					
Voltage, Vil Max.	1, 9		10			3		_	_	3					
VIL MAX.	1.5,13.5		15			4		-	-	4					
Input High	0.5, 4,5		5		3	.5		3,5	-	_	V				
Voltage,	1, 9		10			7		7	_]					
VIH Min.	1.5,13,5	_	15		1	1		7.1	_	_					
Input Current IJN Max.	-	0,18	18	±0,1				-	±10−5	±0.1	μΑ				

DYNAMIC ELECTRICAL CHARACTERISTICS at T $_A$ = 25°C, C $_L$ = 50 pF, Input t_r,t_f = 20 ns, R $_L$ = 200 k Ω

CHARACTERISTIC	TEST CONDITIONS	LIM			
CHARACIERISTIC	V _{DD} (V)	Тур.	Max.	UNITS	
Propagation Delay Time:	5	175	350	ns	
tPHL, tPLH	10	80	160	١.	
	15	60	120		
	5	100	200		
Transition Time	10	50	100	ns	
tTHL, tTLH	15	40	80	i	
Input Capacitance, C _{IN}	_	5	7.5	pF	

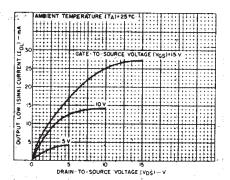


Fig. 2 — Typical output low (sink) current characteristics.

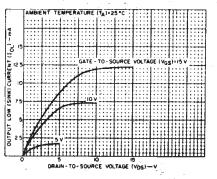


Fig. 3 — Minimum output fow (sink) current characteristics.

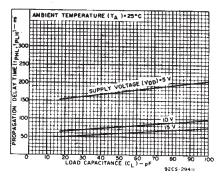


Fig. 4 — Typical propagation delay time as a function of load capacitance.

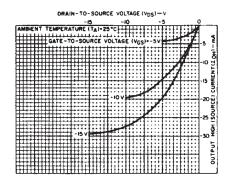


Fig. 5 — Typical output high (source) current characteristics.

TABLE II - CODE CONVERSION CHART

Γ					INPU	TO	ODES	;		Γ											_				
				Hexa Decid		Di	cima)																	
	NP	UT	S	IT	IŢ ΑΥ	EXCESS-3	EXCESS-3 GRAY	AIKEN	4-2-2-1					ı	ou	TP	UT	N	UM	8 E	R				
D	С	В	Α	4-81 BIN	45 88	Ä	35	₹	4.2	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0	0	0	0	0	0			0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	0	1	1	1			1	1	0	1	0,	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	1	0	2	3		0	2	2	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	1	1	3	2	0	3	3		0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
0	1	0	0	4	7	1	4	4		0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
0	1	0	1	5	6	2		Ц	3	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
0	1	1	0	6	4	3	1	Ц	4	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
0	1	1	1	7	5	4	2	Ц	Ц	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
1	0	0	0	8	15	5				0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
1	0	0	1	9	14	6			5	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
1	0	1	0	10	12	7	9		6	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
1	0	1	1	11	13	8		5		0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
1	1	0	0	12	8	9	5	6		0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0
1	1	0	1	13	9		6	7	7	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
1	1	1	0	14	11	L	8	8	8	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
1	1	1	1	15	10		7	9	9	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

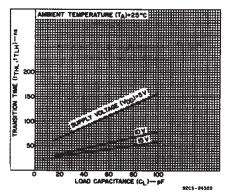


Fig. 8 — Typical transition time as a function of load capacitance.

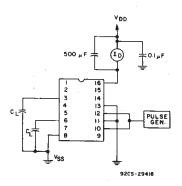


Fig. 10 — Dynamic power dissipation test circuit.

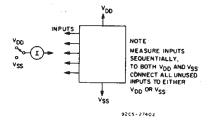


Fig. 9 - Input current test circuit.

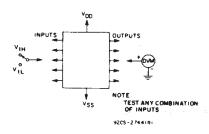


Fig. 11 — Input voltage test circuit.

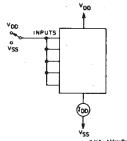


Fig. 12 — Quiescent device current test circuit.

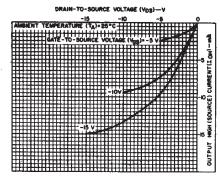


Fig. 6 — Minimum output high (source)

current characteristics.

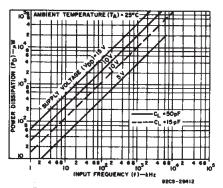


Fig. 7 — Typical dynamic power dissipation as a function of input frequency.

TYPICAL APPLICATIONS

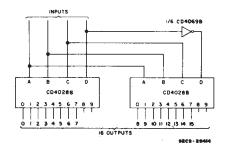
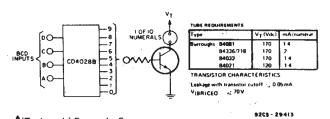


Fig. 13 — Code conversion circuit.

The circuit shown in Fig.13 converts any 4-bit code to a decimal or hexadecimal code. Table 2 shows a number of codes and the decimal or hexadecimal number in these codes which must be applied to the input terminals of the CD4028B to select a particular output. For example: in order to get a high on output No. 8 the input must be either an 8 expressed in 4-Bit Binary code, a 15 expressed in 4-Bit Gray code, or a 5 expressed in Excess-3 code.

CD4028B Types



[♠](Trademark) Burroughs Corp.

Fig. 14 — Neon readout (Nixie Tube $^{f A}$) display application.

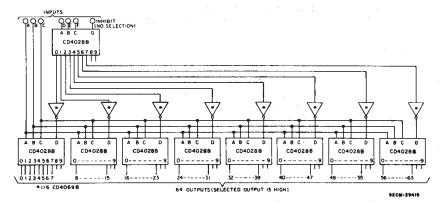
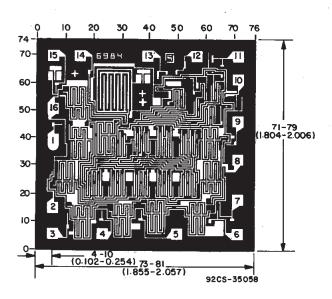


Fig. 15 - 6-bit binary to 1-of-64 address decoder.



CD4028BH DIMENSIONS AND PAD LAYOUT

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3}) inch).

PACKAGE OPTION ADDENDUM



ti.com 27-May-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CD4028BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4028BF	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4028BF3A	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
CD4028BM	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4028BM96	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4028BM96E4	ACTIVE	SOIC	D	16	2500	TBD	Call TI	Call TI
CD4028BME4	ACTIVE	SOIC	D	16	40	TBD	Call TI	Call TI
CD4028BMT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4028BMTE4	ACTIVE	SOIC	D	16	250	TBD	Call TI	Call TI
CD4028BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4028BNSRE4	ACTIVE	SO	NS	16	2000	TBD	Call TI	Call TI
CD4028BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4028BPWE4	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4028BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4028BPWRE4	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

27-May-2005

***************************************	27 May 2003
In no event shall TI's liability arising out of such into Customer on an annual basis.	formation exceed the total purchase price of the TI part(s) at issue in this document sold by TI

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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